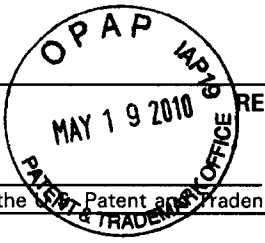


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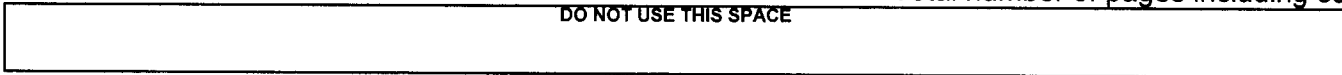
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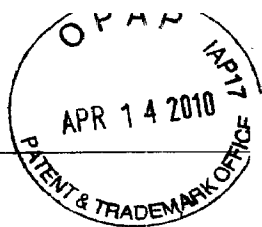
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1)	<u>山本 敬一</u> <i>(Signature)</i>	<u>Keichi YAMAMOTO</u> <i>(Type Name)</i>	<u>Jun 18, 2008</u> <i>(Date)</i>
2)	<u>Lorn Okada</u> <i>(Signature)</i>	<u>Toru OKADA</u> <i>(Type Name)</i>	<u>June 18, 2008</u> <i>(Date)</i>

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IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

1) 山本 敬一 Keiichi YAMAMOTO Jun 18, 2008
(Signature) *(Type Name)* *(Date)*

2) Toru Okada Toru OKADA June 18, 2008
(Signature) *(Type Name)* *(Date)*